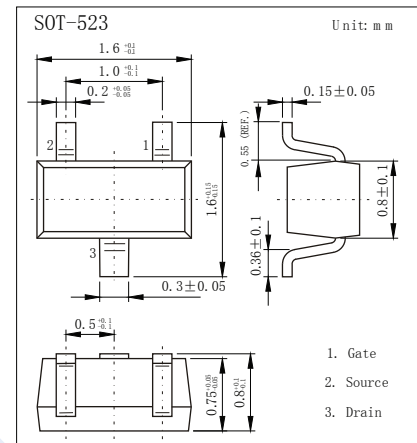
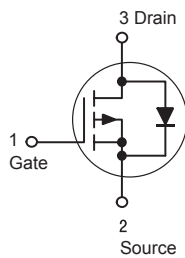


## P-Channel MOSFET

## 2SJ3501

## ■ Features

- $V_{DS}(V) = -50V$
- $I_D = -130\text{ mA}$
- $R_{DS(ON)} < 10\Omega$  ( $V_{GS} = -5\text{ V}$ )

■ Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-50	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current @ $T_A = 25^\circ\text{C}$	$I_D$	-130	mA
Pulsed Drain Current ( $t_p \leq 10\ \mu\text{s}$ )	$I_{DM}$	-520	
Power Dissipation	$P_D$	150	mW
Thermal Resistance Junction- to-Ambient	$R_{thJA}$	833	$^\circ\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-55 to 150	

## P-Channel MOSFET

## 2SJ3501

## ■ Electrical Characteristics (Ta = 25°C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>bss</sub>	I <sub>D</sub> =-250μA, V <sub>GS</sub> =0V	-50			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V			-0.1	μA
		V <sub>DS</sub> =-50V, V <sub>GS</sub> =0V			-15	
		V <sub>DS</sub> =-50V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			-60	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±10	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.8		-2.0	V
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =-5V, I <sub>D</sub> =-100mA			10	Ω
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =-25V, I <sub>D</sub> =-100mA, f=1.0kHz	50			mS
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =-5V		30		pF
Output Capacitance	C <sub>oss</sub>			10		
Reverse Transfer Capacitance	C <sub>rss</sub>			5		
Gate Charge	Q <sub>T</sub>			6000		pC
Turn-On DelayTime	t <sub>d(on)</sub>	V <sub>DD</sub> = -15 V, I <sub>D</sub> = -2.5 A, R <sub>L</sub> = 50Ω		2.5		ns
Turn-On Rise Time	t <sub>r</sub>			1		
Turn-Off DelayTime	t <sub>d(off)</sub>			16		
Turn-Off Fall Time	t <sub>f</sub>			8		
Maximum Body-Diode Continuous Current	I <sub>S</sub>				-0.13	A
Pulsed Current	I <sub>SM</sub>				-0.52	
Diode Forward Voltage (Note 2.)	V <sub>SD</sub>	I <sub>S</sub> =-0.13A, V <sub>GS</sub> =0V			-1.2	V

Note 1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

2. Switching characteristics are independent of operating junction temperature.

## ■ Marking

Marking	PD
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### P-Channel MOSFET

### 2SJ3501

■ Typical Characteristics

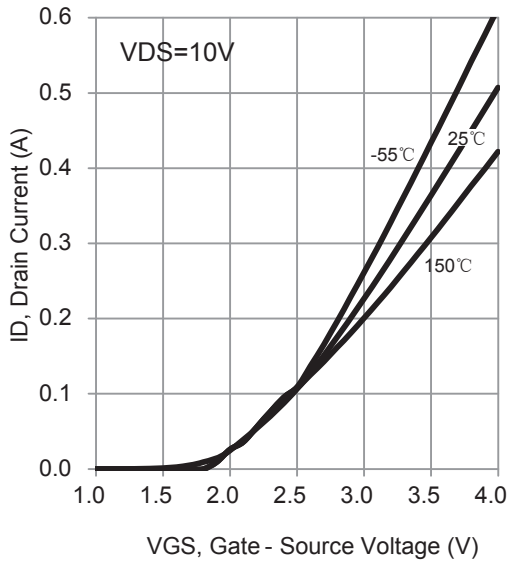


FIG.1 Transfer Characteristics

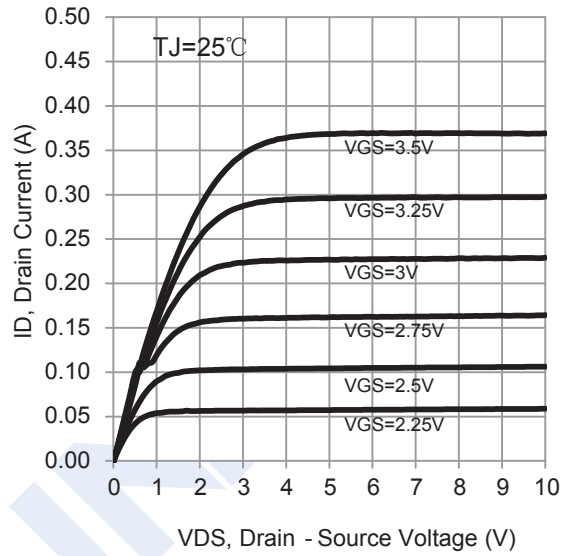


FIG.2 On-Region Characteristics

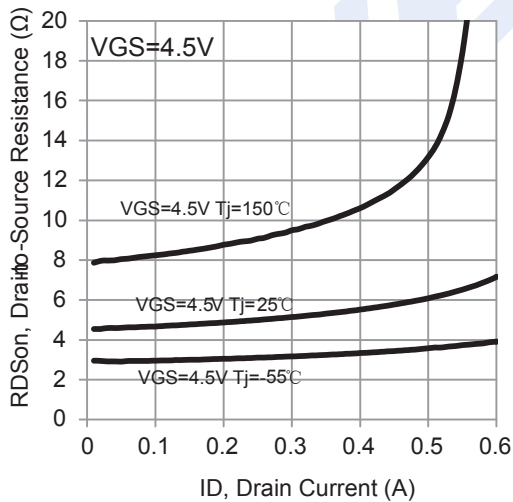


FIG.3 On-Resistance versus Drain Current

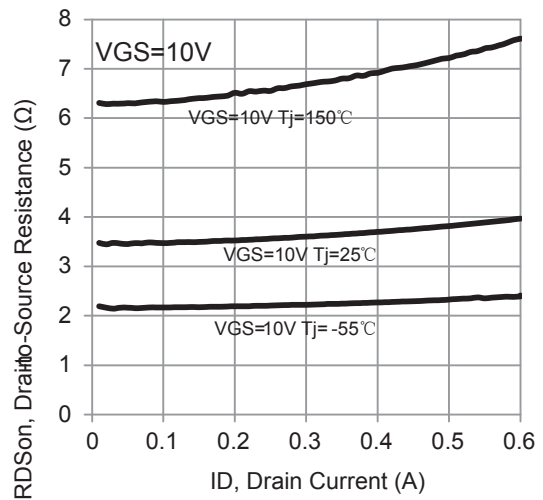


FIG.4 On-Resistance versus Drain Current

## P-Channel MOSFET

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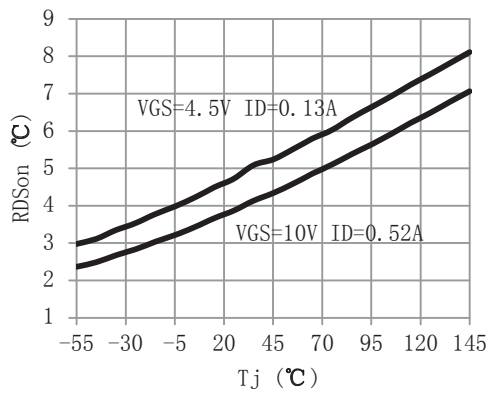


FIG.5 On-Resistance Variation with Temperature

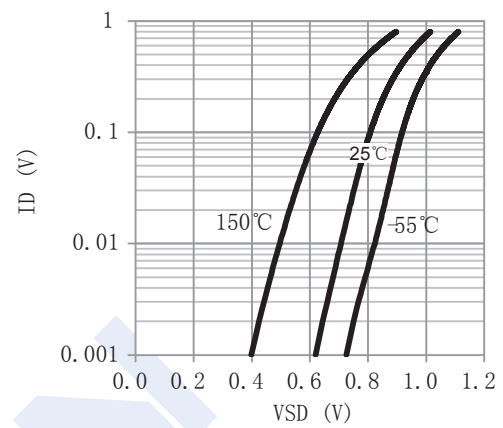


FIG.6 Body Diode Forward Voltage